120			
Docket No.:	P-0711	 	

DECLARATION AND POWER OF ATTORNEY

	Additional to white	MITORIAL I
As a below named inventor, I hereb	by declare that:	
My residence, post office and citizen	nship are as stated below next to my name	•
I believe I am the original, first and plural names are listed below) of the	l sole inventor (if only one name is listed e subject matter claimed and for which a p	below) or an original, first and joint inventor (if natent is sought on the invention entitled
UPGRADE SY:	STEM FOR SOFTWARE IN ELECTRIC	CHOME APPLIANCES
		, the specification of which
[X] is attached hereto [] was amended on	filed on as Application (if applicable)	Serial No and was
I hereby state that I have reviewed a amended by any amendment referre	and understand the contents of the above	identified specification, including the claims, as
I acknowledge the duty to disclose 37, Code of Federal Regulations, Se	information which is known to me to be ction 1.56(a).	material to patentability in accordance with Title
inventor's certificate, or 365(a) of United States of America, listed bel	any PCT international application which ow and have also identified below, by che	(b) of any foreign application(s) for patent or designated at least one country other than the cking the box, any foreign application for patenting date before that of the application on which
Prior Foreign Application(s):		Foreign Filing Date
Number 2002/4893	<u>Country</u> <u>Republic</u> of Korea	Month/Day/Year January 28, 2002
I hereby claim the benefit under 35	U.S.C. 119(e) of any United States provisi	ional application(s) listed below.
Application Number(s):	Filing Date (Mon	th/Day/Year)
application designating the United this application is not disclosed in the paragraph of 35 U.S.C. 112, I acknow CFR 1.56 which became available bedate of this application.	States of America, listed below and, insof he prior United States or PCT internation owledge the duty to disclose information	plication(s), or 365(c) of any PCI international ar as the subject matter of each of the claims of al application in the manner provided by the first which is material to patentability as defined in 37 ation and the national or PCI international filing
Prior U. S. Application or PCT Parent Number	Filing Date (Month/Day/Year)	Parent Patent Number (if applicable)
PCT/KR2003/000197	01/28/2003	
I hereby declare that all statements	made herein of my own browledge are	min and that all attenuants made an information

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Tale 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.



I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vazquez, Registration No. 38,647; Michael J. Cornelison, Registration No. 40,395; and Stuart I. Smith, Registration No. 42,159; and Carol L. Druzbiek, Registration No. 40,287, all of

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with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them.

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